Enquiry No: ChE/AS/April-2012/02 Dated: April 20, 2012

Last date: April 30, 2012

Enquiry letter for the Purchase of (Ti) & Copper (Cu) Metallic Substrates

Titanium (Ti) Metallic Substrate: 10x10x0.5 mm, 1side polished Quantity: 20pc

Specifications:

- ➤ Polycrystal Ti metallic substrate
- ➤ Purity: > 99.9%
- > Density: 4.506 g/cm³
- ➤ Melting Point: 1668°C
- 1. \triangleright Size: 10x10x0.5 mm
 - ➤ Surface finish: One side optical polished, < 10A Ra by AFM
 - Application: substrates for metal, alloy film and biological materials

Cu Metallic Substrate (polycrystalline) 10x10x0.5mm, 1 side polished **Quantity: 50pc**

Specifications:

- ➤ Cu Metallic Substrate (polycrystalline)
- 2. Purity: 99.99%
 - > Size: 10x10x0.5 mm
 - Orientation: N/A
 - ➤ Surface finish (RMS or Ra): One side polished < 30A
 - Packing: in 1000 class clean room with vacuumed bag
 - Application: substrates for metal, alloy film and biological materials

TERMS AND CONDITIONS:

- 1. Technical and commercial bids should be sealed in two different envelopes. Kindly mention tender enquiry number on the top of envelop.
- 2. FOB and CIF IIT Kanpur warehouse prices must be mentioned separately
- 3. Quotation must accompany the proprietary certificate in case of sole manufacturer.
- 4. Agency certificate must be provided in case of Indian agent representing foreign supplier.
- 5. Offer validity: 60 days
- 6. Delivery Period

Quotations will be rejected if any points laid in terms and conditions section are not clearly mentioned/attached with quotation.

Kindly send your offer in a sealed envelope marked "Ti/Cu Metallic Substrate-April 2012" so as to reach us on or before April 30, 2012 to the following address:

Prof. Ashutosh Sharma
Thematic Unit of Excellence
Department of Chemical Engineering
Indian Institute of Technlogy Kanpur
Kanpur 208016 INDIA

You may also send a soft copy of your quotation by mail to Mr. Rajesh Sharma at sharmar@iitk.ac.in along with hard copy to above mentioned address.